

Description

The SPNS-1106S is a fast recovery diode of 600 V / 10 A. Well-balanced characteristics between lower V_F and fast recovery are ensured, achieving loss reduction. The maximum $t_{\rm rr}$ of 100 ns is realized by optimizing a life-time control. The low thermal resistance package achieves high performance in terms of heat dissipation.

Features

• V _{RM}	600 V
• I _{F(AV)}	10 A
• V _F	
• t _{rr}	100 ns
• Bare Leads: Ph free (RoHS Compliant)	

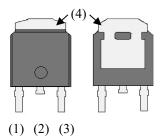
- Bare Leads: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0
- Flow Soldering Available (MSL 1)

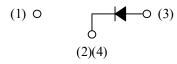
Applications

- PFC Circuit
- Freewheeling Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

Package

TO252-2L





- (1) NC
- (2) Cathode
- (3) Anode
- (4) Cathode

Not to scale

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V_{RSM}		600	V
Repetitive Peak Reverse Voltage	V_{RM}		600	V
Average Forward Current	I _{F(AV)}	See Figure 3 and Figure 4	10	A
Surge Forward Current	I_{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	100	A
I ² t Limiting Value	I^2t	$1 \text{ ms} \le t \le 10 \text{ ms}$	50	A^2s
Junction Temperature	T_{J}		-55 to 150	°C
Storage Temperature	T_{STG}		-55 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop V _F	3.7	$T_J = 25 ^{\circ}\text{C}, I_F = 10 \text{A}$	_	_	1.3	V
	$T_J = 100 ^{\circ}\text{C}, I_F = 10 \text{A}$	_	1.0	_	V	
Reverse Leakage Current	I_R	$V_R = V_{RM}$	_	_	100	μΑ
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$	_		10	mA
Reverse Recovery Time	t_{rr}	$I_F = I_{RP} = 100 \text{ mA},$	_		100	ns
		90% recovery point, T _J = 25 °C				ns
Thermal Resistance (1)	R _{th(J-C)}	(2)		_	5.0	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Package Weight		_	0.32	_	g

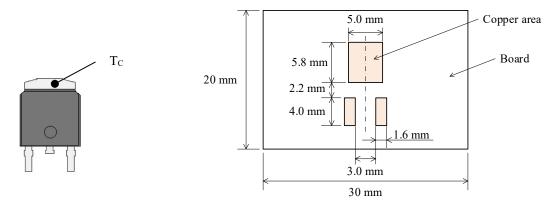


Figure 1. Case Temperature Measurement

Figure 2. Glass-epoxy Board

⁽¹⁾ Refers to thermal resistance between junction and the case.

⁽²⁾ The device is mounted on the glass-epoxy board (PCB: 42 mm × 32 mm in size, 1 mm in thickness, copper area: see Figure 2).

Derating Curves

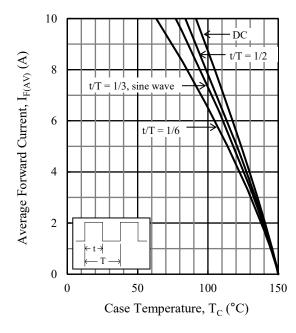


Figure 3. $I_{F(AV)}$ vs. T_C ($T_J = 150$ °C, $V_R = 0$ V)

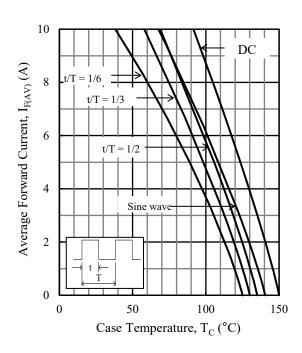


Figure 4. $I_{F(AV)}$ vs. T_C ($T_J = 150$ °C, $V_R = 600$ V)

Characteristic Curves

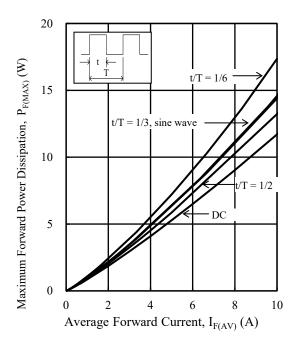


Figure 5. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150$ °C)

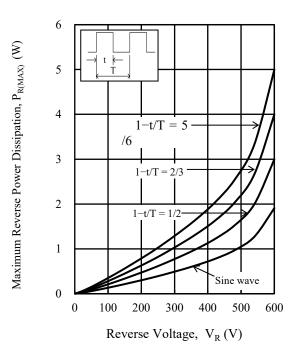


Figure 6. $P_{R(MAX)}$ vs. V_R ($T_J = 150$ °C)

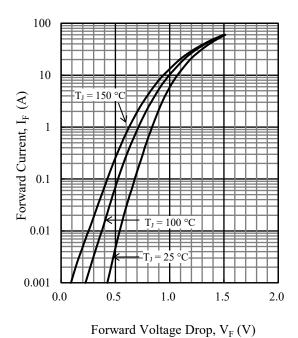


Figure 7. Typical Characteristics: I_F vs. V_F

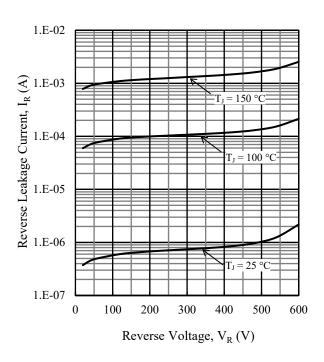


Figure 8. Typical Characteristics: I_R vs. V_R

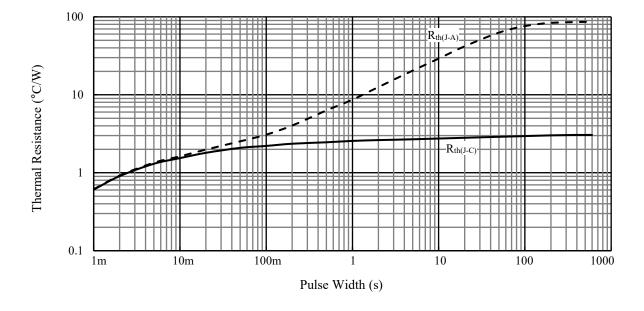
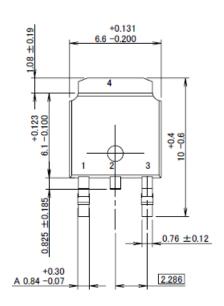
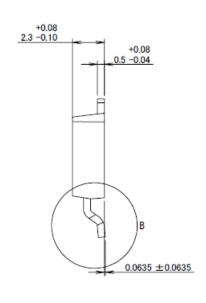


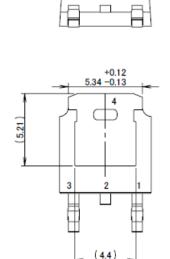
Figure 9. Typical Transient Thermal Resistance Characteristics

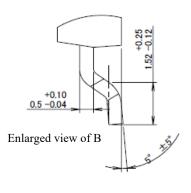
Physical Dimensions

• TO252-2L Package









NOTES:

- Dimensions in millimeters
- All the dimensions exclude mold flashes, protrusions, and gate burrs.
- Bare lead frame: Pb-free (RoHS compliant)
- Moisture Sensitivity Level 1 (MSL 1)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow: 260 °C / 10 s, 1 time

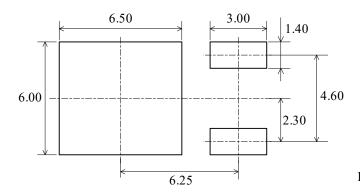
Reflow:

Preheat: 150 °C to 200 °C / 60 s to 120 s

Solder heating: 255 °C / 30 s, 3 times (260 °C peak)

Soldering Iron: 350 °C / 3.5 s, 1 time

• TO252-2L Land Pattern Example



Dimensions in millimeters

Marking Diagram

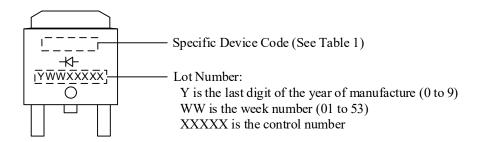


Table 1. Specific Device Code

Specific Device Code	Part Number
NS1106	SPNS-1106S

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